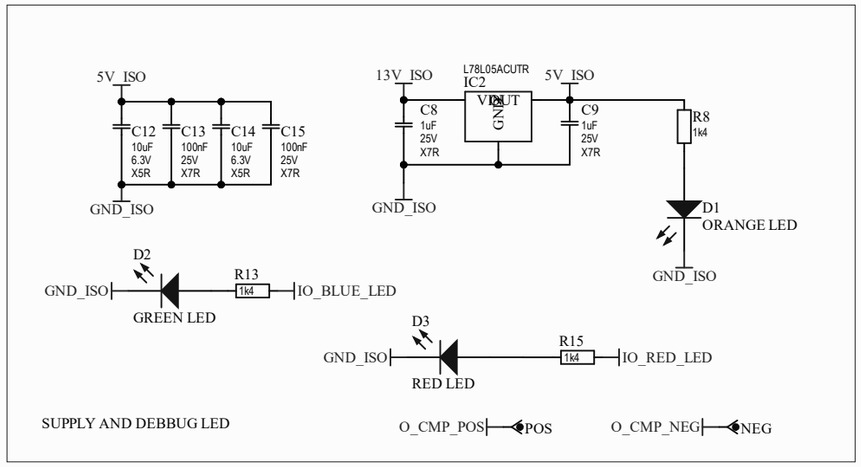
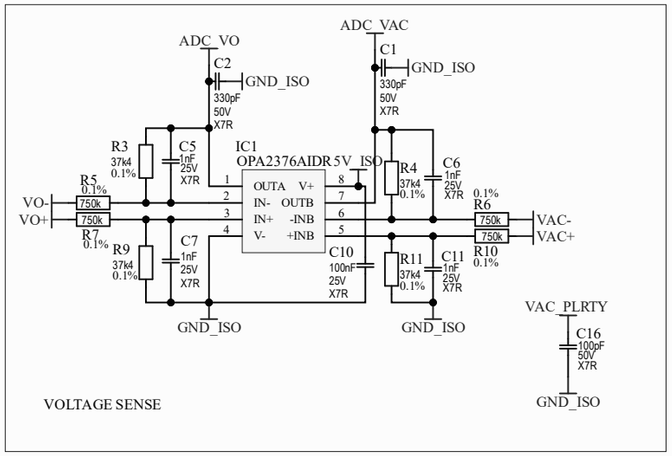
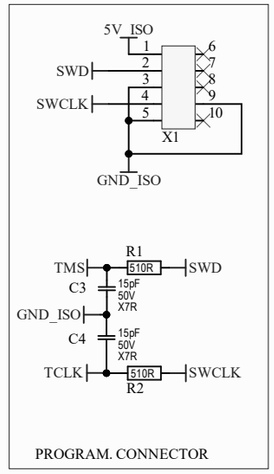
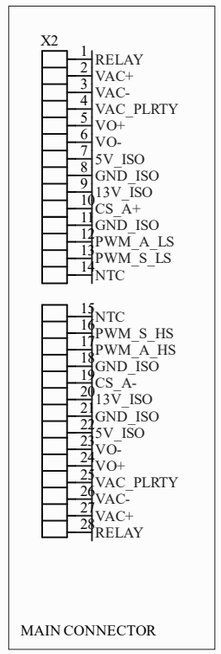
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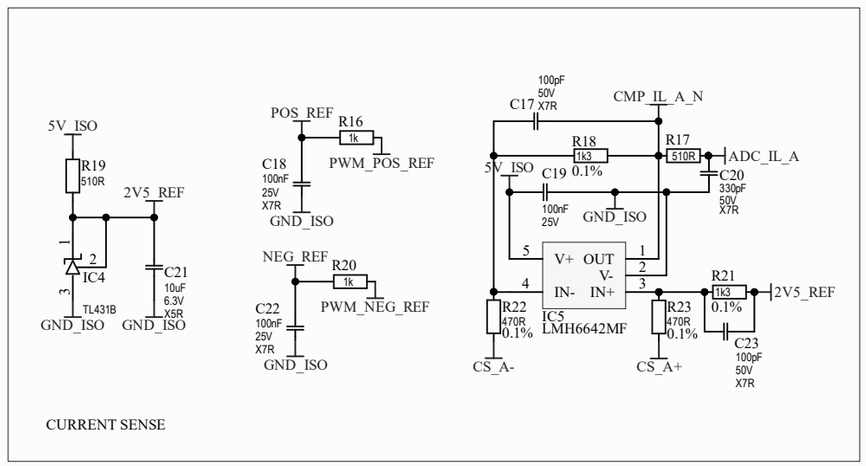
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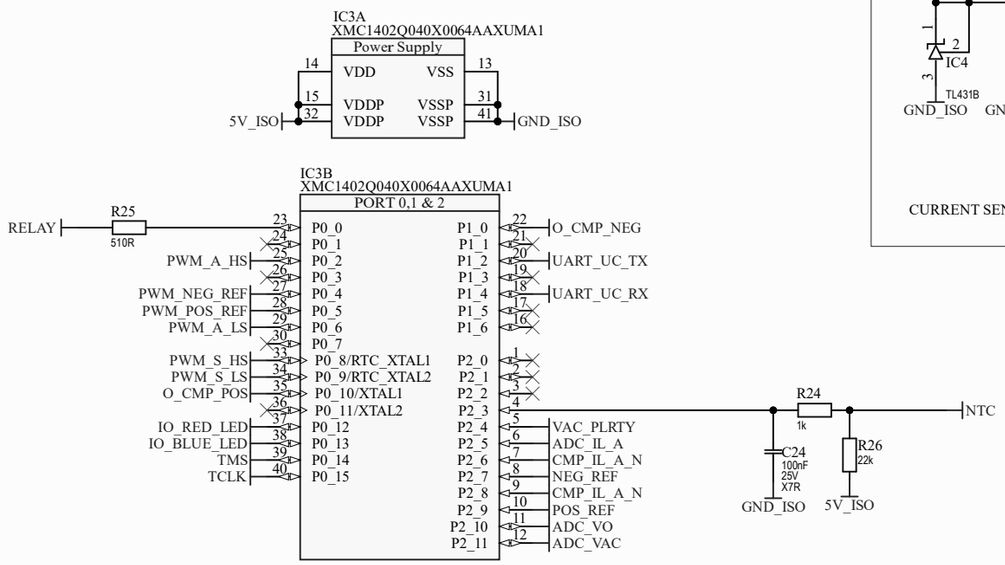










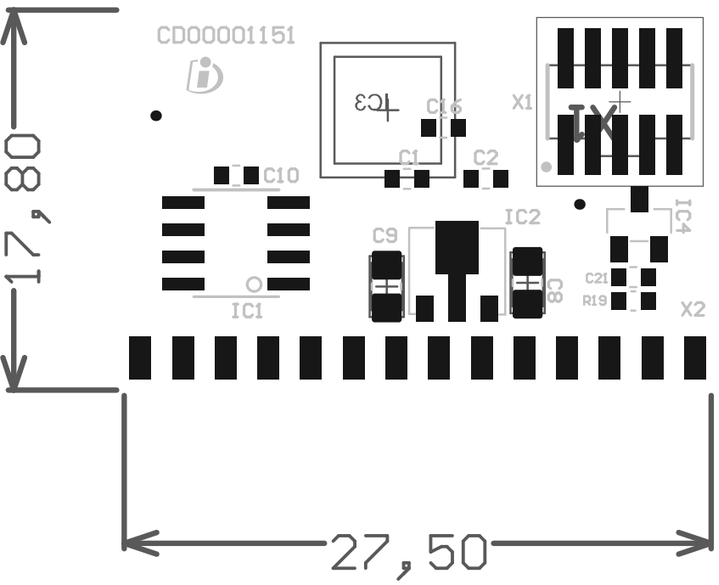


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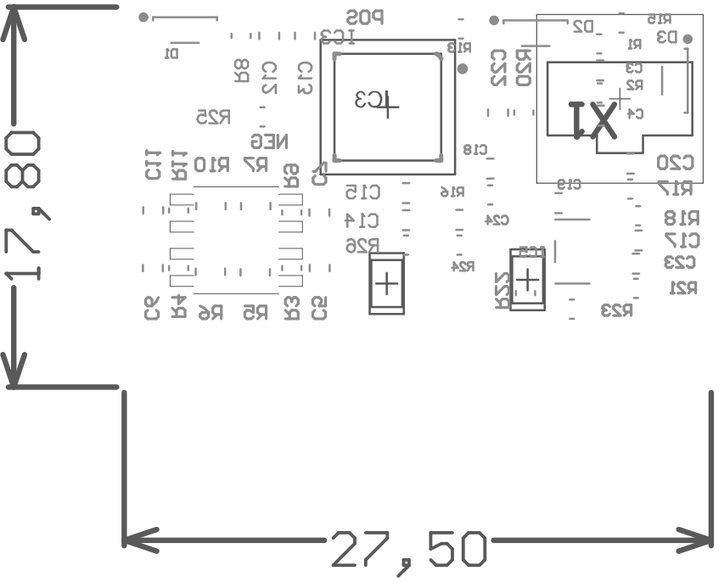
IFAT PSS EPIC HVC TM SAE
Infineon Technologies Austria AG
Siemensstraße 2, 9500 Villach, Österreich

Title	EVAL_3K3W_TP_PFC_CC Control Card
Variant	[No Variations]
Author: Matteo-Alessandro Kutschak; David Meneses	
Date: 08.05.2023 Time: 09:59:03	
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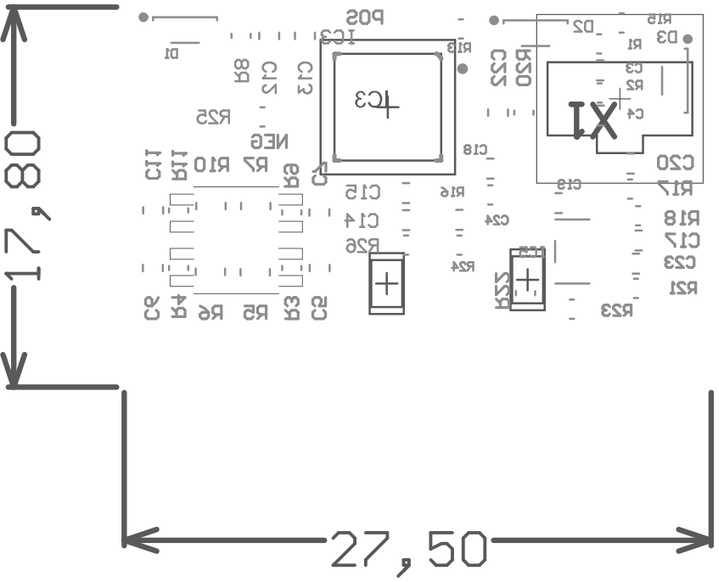
Layer	Name	Material	Thickness	Constant	Board Layer Stack
	Top Overlay				
	Top Solder	Solder Resist	0,010mm	3.5	
1	L1		0,035mm		
	Dielectric 1	FR-4	0,100mm	4.2	
2	L2		0,035mm		
	Dielectric 3	FR-4	1,000mm	4.2	
3	L3		0,035mm		
	Dielectric 2	FR4	0,100mm	4.2	
4	L4		0,035mm		
	Solder Side	Solder Resist	0,010mm	3.5	
	Bottom Overlay				



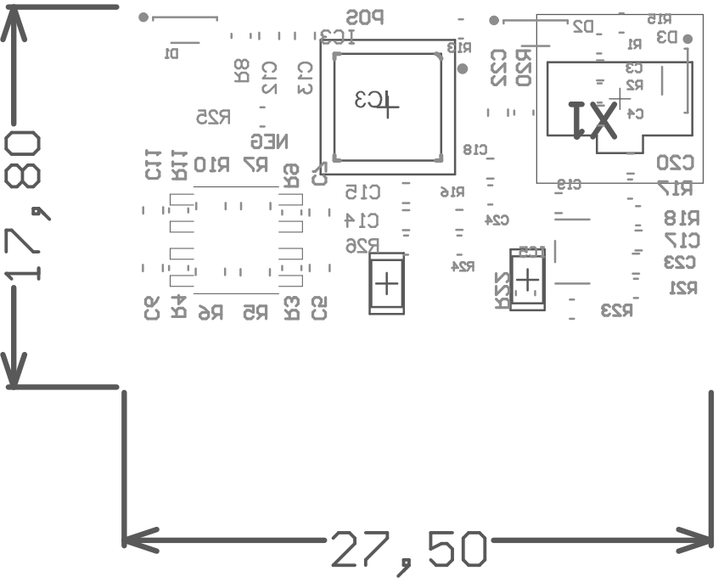
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4	L4		0,035mm		
	Solder Side	Solder Resist	0,010mm	3.5	
	Bottom Overlay				



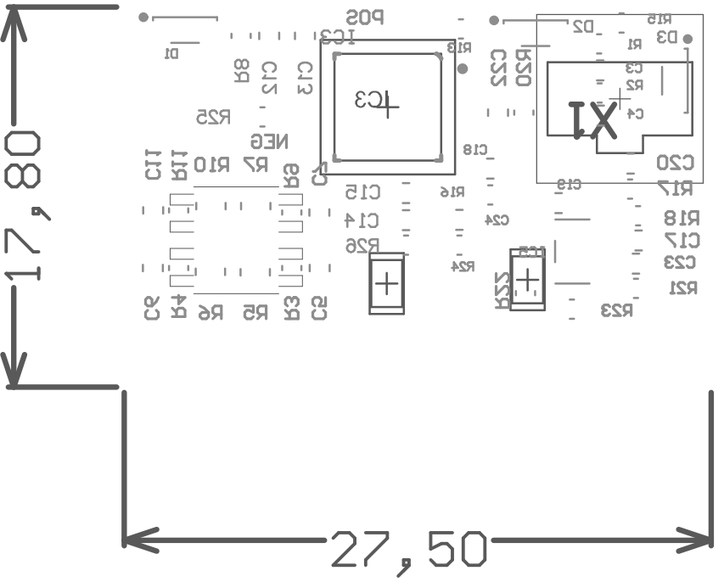
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